

# MMD65R900Q

### 650V 0.90Ω N-channel MOSFET

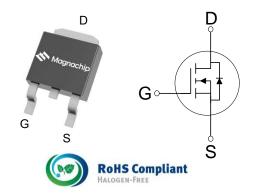
### Description

MMD65R900Q is power MOSFET using Magnachip's advanced super junction technology that can realize very low on-resistance and gate charge. It will provide much high efficiency by using optimized charge coupling technology. These user friendly devices give an advantage of low EMI to designers as well as low switching loss.

### ■ Key Parameters

Parameter	Value	Unit
$V_{DS}$ @ $T_{j, max}$	700	V
R <sub>DS(on), max</sub>	0.90	Ω
$V_{GS(th),\ typ}$	3	V
I <sub>D</sub>	4.7	Α
Q <sub>g, typ</sub>	11.1	nC

#### ■ Package & Internal Circuit



#### Features

- Low power loss by high speed switching and low on-resistance
- 100% avalanche tested
- Green package Pb-free plating, Halogen-free

### Applications

- PFC power supply stages
- Switching applications
- Adapter

### Ordering Information

Order Code	Marking	Temp. Range	Package	Packing	RoHS Status
MMD65R900QRH	65R900Q	-55 ~ 150°C	TO-252	Reel	compliant



### ■ Absolute Maximum Rating (T<sub>c</sub>=25°C unless otherwise specified)

Parameter	Symbol	Rating	Unit	Note
Drain – source voltage	$V_{ extsf{DSS}}$	650	V	
Gate – source voltage	V <sub>GSS</sub>	±30	V	
Continuous dusin summent		4.7	Α	T <sub>C</sub> = 25°C
Continuous drain current	I <sub>D</sub>	3.0	Α	T <sub>C</sub> = 100°C
Pulsed drain current <sup>(1)</sup>	I <sub>DM</sub>	14.1	Α	
Power dissipation	P <sub>D</sub>	34.7	W	
Single - pulse avalanche energy	E <sub>AS</sub>	50	mJ	
MOSFET dv/dt ruggedness	dv/dt	50	V/ns	
Diode dv/dt ruggedness <sup>(2)</sup>	dv/dt	15	V/ns	
Storage temperature	$T_{stg}$	-55 ~150	°C	
Maximum operating junction temperature	Tj	150	°C	

<sup>1)</sup> Pulse width t<sub>P</sub> limited by T<sub>j,max</sub>.

### **■** Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-case max	R <sub>thjc</sub>	3.4	°C/W
Thermal resistance, junction-ambient max <sup>(3)</sup>	$R_{thja}$	62	°C/W

<sup>3)</sup> Device mounted on minimal footprint of PCB.

<sup>2)</sup>  $I_{SD} \leq I_{D}$ ,  $V_{DS peak} \leq V_{(BR)DSS}$ .



### ■ Static Characteristics (T<sub>c</sub>=25°C unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Drain – source breakdown voltage	V <sub>(BR)DSS</sub>	650	-	-	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250uA
Gate threshold voltage	$V_{\text{GS(th)}}$	2	3	4	٧	$V_{DS} = V_{GS, I_D} = 250uA$
Zero gate voltage drain current	I <sub>DSS</sub>	-	ı	1	uA	V <sub>DS</sub> = 650V, V <sub>GS</sub> = 0V
Gate leakage current	I <sub>GSS</sub>	-	-	100	nA	$V_{GS} = \pm 30 V, V_{DS} = 0 V$
Drain-source on state resistance	R <sub>DS(ON)</sub>	-	0.8	0.9	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 1.5A

### ■ Dynamic Characteristics (T<sub>c</sub>=25°C unless otherwise specified)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Input capacitance	C <sub>iss</sub>	-	384	-		
Output capacitance	Coss	-	439	-		$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz
Reverse transfer capacitance	C <sub>rss</sub>	-	19.5	-	pF	
Effective output capacitance energy related <sup>(4)</sup>	C <sub>o(er)</sub>	-	14.5	-		$V_{DS} = 0V \text{ to } 520V,$ $V_{GS} = 0V, f = 1.0MHz$
Turn on delay time	t <sub>d(on)</sub>	-	13.5	-	ns	$V_{GS} = 10V, R_G = 25\Omega,$ $V_{DS} = 325V, I_D = 4.7A$
Rise time	t <sub>r</sub>	-	24	1		
Turn off delay time	$t_{d(off)}$	-	56	-		
Fall time	t <sub>f</sub>	-	23.5	-		
Total gate charge	$Q_g$	-	11.1	-		
Gate – source charge	$Q_{gs}$	-	4.5	-	nC	$V_{GS} = 10V, V_{DS} = 520V,$ $I_{D} = 4.7A$
Gate – drain charge	$Q_gd$	-	2.6	-		
Gate resistance	R <sub>G</sub>	-	20	-	Ω	V <sub>GS</sub> = 0V, f = 1.0MHz

<sup>4)</sup>  $C_{\text{o(er)}}$  is a capacitance that gives the same stored energy as  $C_{\text{oss}}$  while  $V_{DS}$  is rising from 0V to 80%  $V_{(BR)DSS}$ 

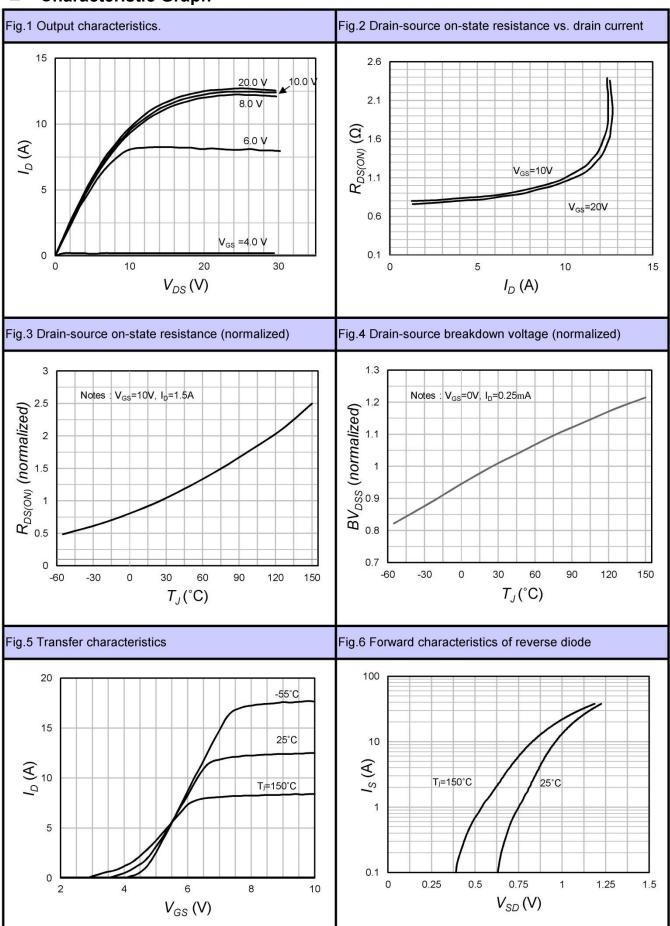


### ■ Reverse Diode Characteristics (T<sub>c</sub>=25°C unless otherwise specified)

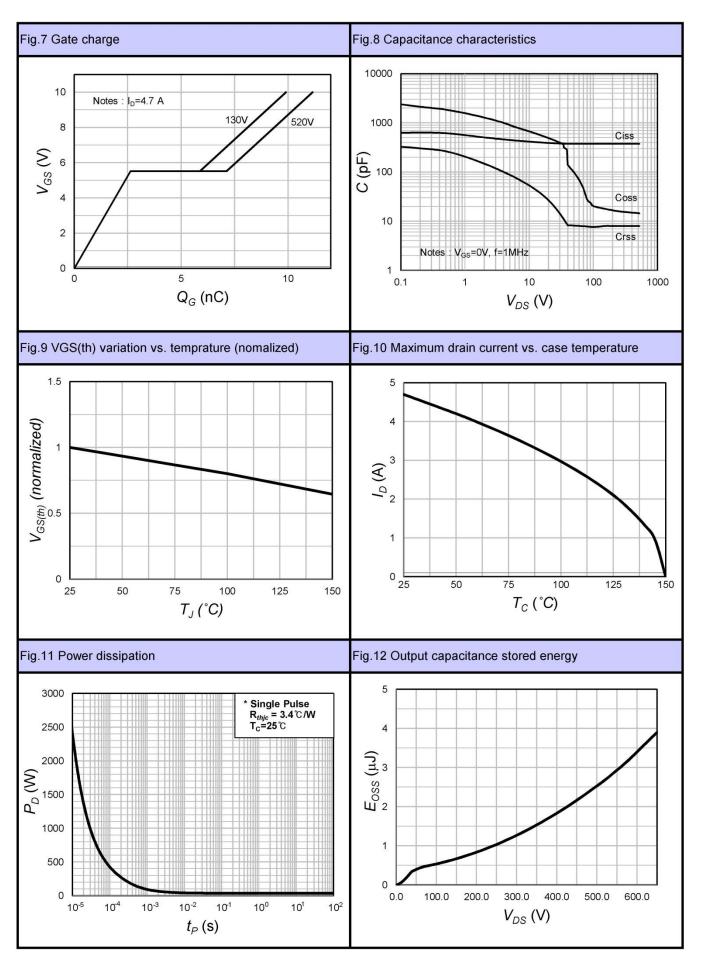
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Continuous diode forward current	Is	-	-	4.7	Α	
Diode forward voltage	$V_{\text{SD}}$	-	-	1.4	V	$I_S = 4.7A, V_{GS} = 0V$
Reverse recovery time	t <sub>rr</sub>	-	263	-	ns	1 470
Reverse recovery charge	$Q_{rr}$	-	1.9	-	uС	$I_S = 4.7A$ di/dt = 100A/us $V_{DD} = 100V$
Reverse recovery current	I <sub>rrm</sub>	-	14.4	-	Α	V DD = 100 V



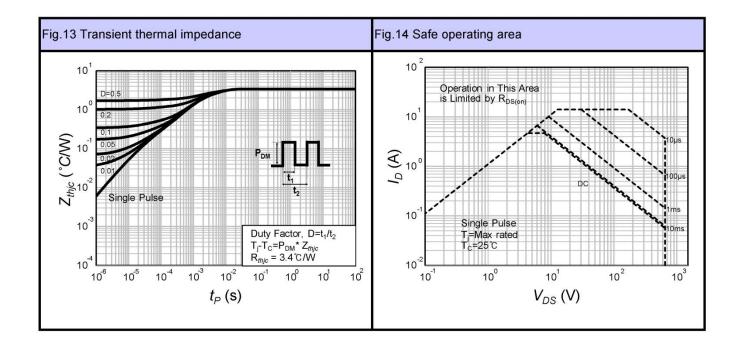
### **■** Characteristic Graph













#### **■** Test Circuit

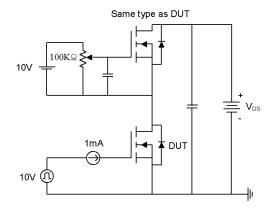


Fig15-1. Gate charge measurement circuit

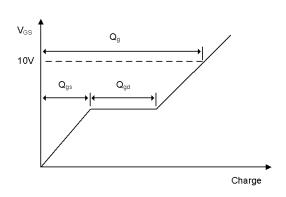


Fig15-2. Gate charge waveform

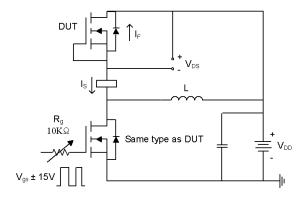


Fig16-1. Diode reverse recovery test circuit

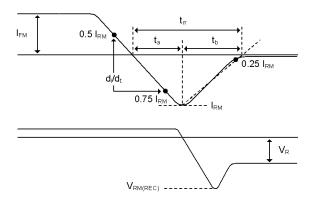


Fig16-2. Diode reverse recovery test waveform

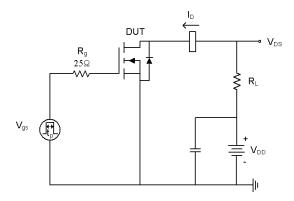


Fig17-1. Switching time test circuit for resistive load

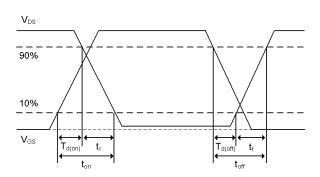


Fig17-2. Switching time waveform

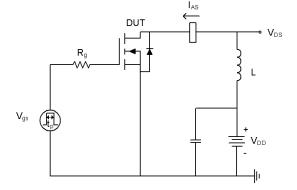


Fig18-1. Unclamped inductive load test circuit

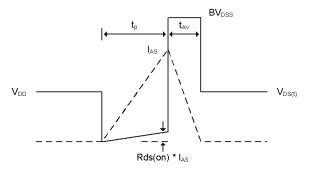
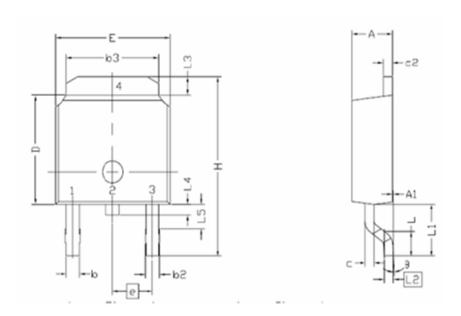


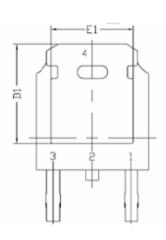
Fig18-2. Unclamped inductive waveform



### **■** Physical Dimension

### TO-252(2L)





### [Unit:mm]

Symbol	Min.	Nom.	Max.
Е	6,35	_	6,73
L	1,40	1,52	1,78
L1		2,74 REF	
L2		0,508 BCS	
L3	0,89	-	1,27
L4	-	-	1,02
L5 D	1,14	_	1,52
D	5,97	6,10	6,22
Н	9,40	_	10,41
b	0,64	-	0,89
b2	0,76	_	1,14
b3	4,95	_	5,46
е		2,286 BSC	
e A	2,18	-	2,39
A1	-	-	0,13
С	0,46	-	0,61
c c2 D1 E1	0,46	-	0,89
D1	5,21	_	_
	4,32	-	_
Θ	0,00	_	10,00

Note: Package body size, length and width do not include mold flash, protrusions and gate burrs.





#### **DISCLAIMER:**

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